

**SPD9711B**
**1-Line,Bi-directional,Thyristor Surge Suppressors**
<http://www.sh-willsemi.com>
**Descriptions**

The SPD9711B is a bi-directional TSS (Thyristor Surge Suppressors). It is specifically designed to protect telecom equipments from damaging overvoltage transients.

The SPD9711B is used to enable equipments to meet various regulatory requirements including GR-1089-CORE, ITU-T K.20, K.21 and K.45, IEC 61000-4-5, IEC 60950, UL 60950, and TIA-968.

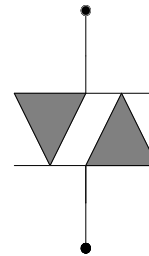
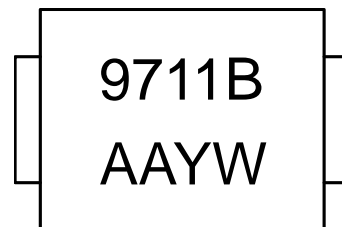
The SPD9711B is available in SMB package. Standard products are Pb-free and Halogen-free.

**Features**

- Peak off-state voltage: 275V Max
- Excellent capability of absorbing transient surge
- Quick response to surge voltage
- Eliminate voltage overshoot caused by fast-rising transients
- Low capacitance:  $C_J = 80\text{pF}$  Max.
- Low peak off-state current:  $<1\mu\text{A}$
- Solid-state silicon technology, non degenerative

**Applications**

- Broadband Equipment such as ADSL/VDSL
- Baseband Equipment such as ISDN
- CATV Equipment
- Customer Premises Equipment (CPE) such as telephones, fax machines, modems and VoIP
- Data lines and security systems


**SMB (DO-214AA)**

**Schematic Diagram**


9711B = Device code  
 AA = Special code  
 Y = Year code  
 W = Week code

**Marking (Top View)**
**Order information**

Device	Package	Shipping
SPD9711B-2/TR	SMB	3000/Tape&Reel

**Electrical characteristics ( $T_A=25^\circ\text{C}$ , unless otherwise noted)**

Part Number	$V_{\text{DRM}}$	$I_{\text{DRM}}$	$V_S^{1)}$	$I_S$	$I_H$	$V_T$	$I_T$	$C_o^{2)}$
	V	$\mu\text{A}$	V	mA	mA	V	A	pF
		Max.	Max.		Max.	Max.		Max.
SPD9711B	275	1	350	800	150	4	2.2	80

Notes:

- 1)  $V_S$  is measured at 100kV/s.
- 2) Off-state capacitance is measured at  $f = 1\text{MHz}$ ,  $V_{\text{DC}} = 2\text{V}$ .

**Surge Ratings**

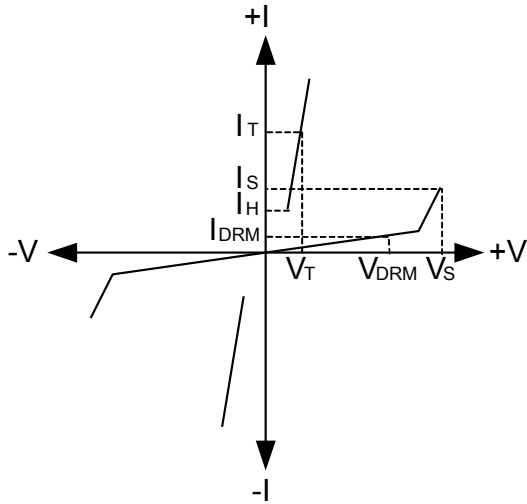
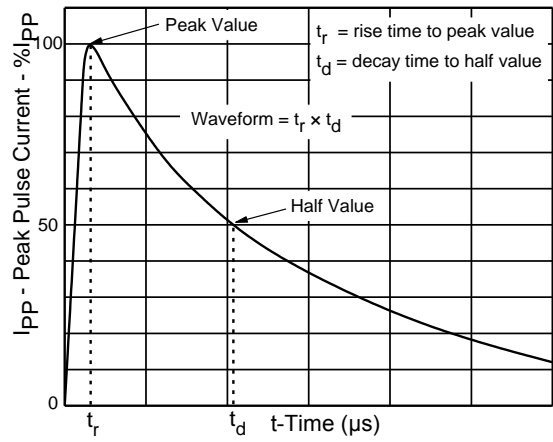
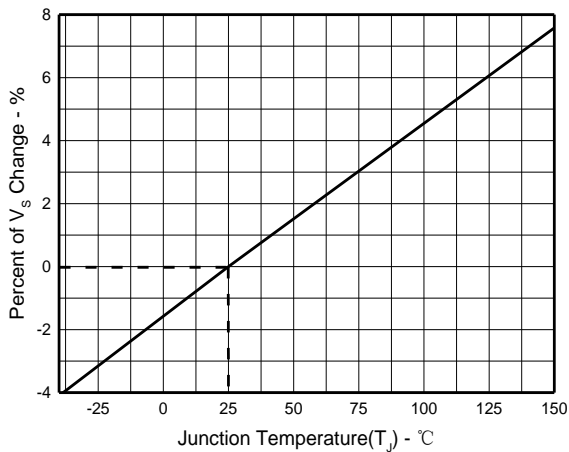
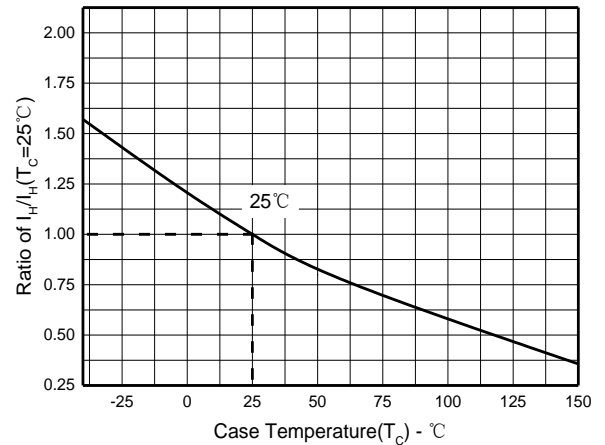
Part Number	8/20 $\mu\text{s}^{1)}$	5/310 $\mu\text{s}^{1)}$
	1.2/50 $\mu\text{s}^{2)}$	10/700 $\mu\text{s}^{2)}$
SPD9711B	400A	6000V/150A

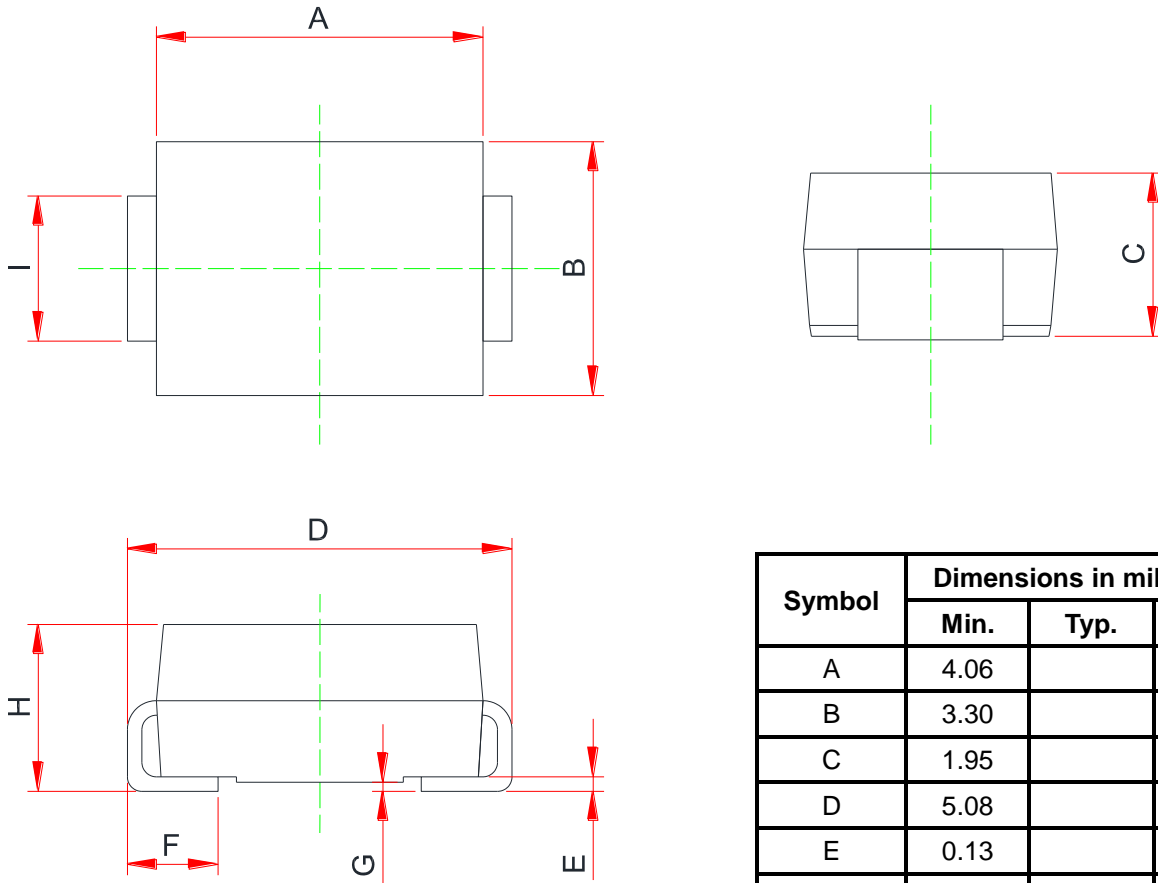
Notes:

- 1) Current waveform.
- 2) Voltage waveform.

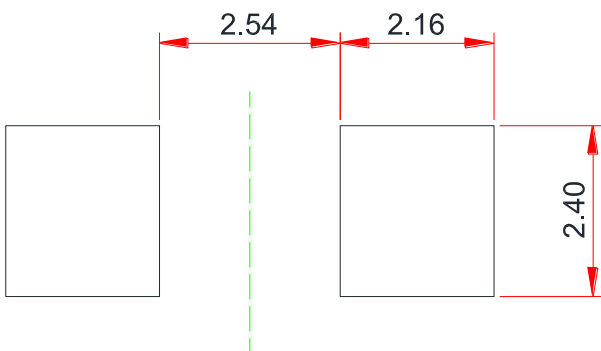
**Thermal considerations**

Parameter	Symbol	Rating	Unit
Operation junction temperature	$T_J$	-40~150	$^\circ\text{C}$
Storage temperature	$T_{\text{STG}}$	-55~150	$^\circ\text{C}$
Lead temperature	$T_L$	260	$^\circ\text{C}$
Junction to ambient thermal resistance	$R_{\theta\text{JA}}$	90	$^\circ\text{C/W}$

**Typical characteristics ( $T_A=25^\circ\text{C}$ , unless otherwise noted)**

**Definitions of electrical characteristics**

**Peak pulse current waveform**

**Normalized  $V_S$  Change vs. Junction Temperature**

**Normalized Holding Current vs. Case Temperature**

**Package outline dimensions**
**SMB**


Symbol	Dimensions in millimeter		
	Min.	Typ.	Max.
A	4.06		4.57
B	3.30		3.94
C	1.95		2.62
D	5.08		5.59
E	0.13		0.31
F	0.76		1.52
G	0.20 Max.		
H	2.10	2.30	2.50
I	1.78	2.00	2.20

**Recommend land pattern (Unit: mm)**

**Notes:**

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.